Effects of Ethylene Glycol Treatment Temperature on the Transfer Characteristics of ZnO

Abdolkarim Afroozeh1,2*, Seyed Ebrahim Pourmand3,4, Alireza Zeinalinezhad5
1-Young Researchers and Elite Club, Jahrom Branch, Islamic Azad University, Jahrom, Iran.
2-The Department General of Fars Province Education, Iran.
3-Department of Optics and Lasers Engineering, Estahban Branch, Islamic Azad University, Estahban, Iran.
4-Young Researchers and Elite Club, Estahban Branch, Islamic Azad University, Estahban, Iran.
5-Chemistry Department, Anar Branch, Islamic Azad University, Anar, Iran.
Email: afroozeh15@yahoo.com

ABSTRACT
In this study, ZnO thin films with different rising temperatures were prepared using the SILAR method. Structural and optical properties affected by temperature treatment were investigated. Moreover, ZnO-channel TFTs were fabricated and their electrical characteristics were evaluated at different temperatures. In this study, the effects of ethylene glycol treatment temperature on the transfer characteristics of ZnO thin film transistors (TFTs), constructed using successive ionic layer adsorption and reaction were investigated. Under high-temperature solution treatments, the TFT device demonstrated the typical positive shift in threshold voltage (∆Vth). The shifting phenomenon results from lower oxygen vacancies attributable to Zn(OH)2 in the films following a rise in the treatment temperature. However, at temperatures higher than 145°C, particle mobility tends to be significantly reduced due to the shedding of ZnO from the surface. As a result, the influence of treatment temperature on SILAR is an essential topic of study.

Keywords: Zinc oxide, Thin film transistor, Successive ionic layer adsorption and reaction.

INTRODUCTION
ZnO-TFTs have attracted a lot of attention because of their potential use as active-matrix liquid crystal display (AMLCD) switching devices [1, 2]. The higher mobility of ZnO-TFTs is suitable for 3D and high-resolution large-area displays. A number of techniques have been employed for fabricating ZnO thin films for application as the active layer in TFTs, such as chemical vapor deposition, sol-gel, spray-pyrolysis, molecular beam epitaxy, pulsed laser deposition, vacuum arc deposition, SILAR and magnetron sputtering [3-5]. Among them, SILAR is the most promising one for the deposition of transparent oxide, because of the high reliability and low cost. Besides, it only requires a low temperature environment and facilitates large-area deposition [6, 7]. Even though there are studies for the differences among various rising procedures involving the use of ethylene, there are very few studies investigating the effect of temperature treatment in ethylene glycol [8, 9].

EXPERIMENTAL TECHNIQUE
Inverted staggered-structure TFTs were fabricated on a glass substrate. A 90 nm-thick Al gate electrode was deposited using thermal evaporation and patterned using a metal mask. A dielectric layer of 200 nm-thick SiO2 was subsequently deposited using plasma-enhanced chemical vapor deposition (PECVD). The active layer was fabricated by depositing a 90 nm-thick ZnO film using the successive ionic layer adsorption and reaction method. ZnCl2 (0.1 M) and concentrated ammonium hydroxide (NH4OH; 29 wt% NH3) were used to prepare a tetra-ammonium zinc complex ([Zn(NH3)4]+2+) solution. NH4OH was added to adjust the pH of the solution to 10. ZnO film growth was performed, through 20 deposition cycles, and then the crystalline and microstructure of the films were studied. During the active layer deposition, the temperature of ethylene glycol was set to 95, 125, and 145°C to convert Zn(OH)2 to ZnO [14]. A 90 nm-
A thick Al layer was deposited using thermal evaporation and patterned as source and drain electrodes. The channel dimensions of the studied TFTs were L = 200 µm and W = 2000 µm. The structure and crystallite size of the deposited films were investigated using X-ray diffraction (XRD). The surface morphologies of the samples were examined using scanning electron microscopy (SEM) and atomic force microscopy (AFM). The optical properties of the ZnO thin films were characterized by ultraviolet-visible-near-infrared (UV-vis-IR) spectrophotometry, photoluminescence (PL) spectroscopy, and X-ray photoemission spectroscopy (XPS). All electrical characteristics were measured using an Agilent B1500A semiconductor device parameter analyzer.

Fig. 1 XRD patterns of ZnO thin films under various temperature treatments.

Fig. 2 AFM image of the ZnO channel layer at temperatures of (a) 95°C, (b) 125°C, and (c) 145°C.

Figure 2 shows the AFM patterns of the ZnO thin films; the patterns observed after rinsing with ethylene glycol at 95°C, 125°C and 145°C were observed to have wurtzite structure with a preferred c-axis orientation of (002) at 2θ = 34°. Peaks due to the plane of wurtzite ZnO were also found, while the peaks were reduced with increasing temperatures. However, the (002) peak has an obvious increase as the temperature rises to 1650°C. Besides, the diffraction angle of the ZnO was increased, indicating better crystallinity with more relaxation. This was the consequence of higher treatment temperatures of the ethylene glycol in the ZnO crystal. Moreover, the full widths at half maximums (FWHM) of ZnO films reduced as Tris increased, possibly due to the increased grain sizes. These consequences demonstrate that the quality of ZnO thin films depends on temperature.
The transmittance spectra of the films deposited at rinsing temperatures of 95°C, 125°C, 145°C are illustrated in Fig. 3. The films are highly transparent in the visible wavelength region. The transmittance increases with increasing treatment temperature. The decrease of transmittance is due to dispersion at the opaque-grain boundaries. In addition, a sharp absorption edge is observed at around 36 nm for all the films.

Figure 4 shows the PL spectra of films measured at different deposition temperatures. All the samples have two prominent peaks. It is well known that the near-band edge emission, at about 380 nm, originates from the radiative recombination process in ZnO. The broad peak corresponding to the emission in the green to yellow region is associated with intrinsic deep level defects in ZnO, such as interstitial oxygen (Oi) and antisite oxygen (OZn). In addition, the luminescence band in the range 44–62 nm is attributed to the presence of Zn(OH)2 in the ZnO thin film. Zn(OH)2 is the cause of the Oi emission band (54 nm). As a result, the spectra indicate that the concentration of Oi in ZnO films increases at low temperatures due to the lack of hydrolysis.

To confirm the effect between the hydrolysis of Zn(OH)2 and rising temperatures, the XPS analysis is presented. An in-depth analysis was performed and the samples were etched more than 50 nm-deep using an Ar ion beam. The peaks at 530 eV and 532 eV can reasonably be attributed to O2- in Zn-O and Zn-OH, respectively, based on values reported elsewhere. At 95°C, excess Zn(OH)2 that exists in the ZnO film causes high-intensity Zn-OH peaks and low-intensity Zn-O bonding. These results indicate that the films were deficient of oxygen at lower temperatures. However, when the film is rinsed at a higher temperature, the transmittance increases due to the decrease of Oi.
temperature, the condition could be reversed because of the decomposition of Zn(OH)₂. Thus, it can be inferred that the PL and XPS results for the ZnO thin films prepared by SILAR are strongly dependent on the treatment temperature.

![Graphs of transfer characteristics at various temperatures](image)

**Fig. 5 Transfer characteristics of SILAR ZnO TFT at various temperatures.**

**Table 1** TFT characteristics with various chemical depositions

<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>Mobility (cm²/Vs)</td>
<td>0.67</td>
<td>3.5</td>
<td>15</td>
<td>0.56</td>
<td>47.8</td>
</tr>
<tr>
<td>1on/1off ratio</td>
<td>106</td>
<td>105</td>
<td>107</td>
<td>104</td>
<td>104</td>
</tr>
</tbody>
</table>

The electrical characteristics of the devices demonstrate that all ZnO TFTs, operated in n-type enhancement mode, require a positive gate voltage to turn on. The ID curve is flat for large VD and hard saturation was observed. The TFTs with ZnO rinsing at 95 °C and 125 °C show similar mobility ~47.8 cm²/Vs, on/off ratio ~104, and SS ~0.9 V/decade. It should be noted that the mobility of ZnO-TFTs, deposited using the SILAR method, is higher than other chemical-processed TFTs shown as Table 1. However, the behavior of the threshold voltage shift under rising temperatures is shown in Fig. 5 (a)-(c). As the temperature increases, the threshold voltage tends to move towards a positive voltage. This phenomenon could be attributed to the reduction at higher rinsing temperatures of oxygen defects, recognized as donors. The results highly correspond to the PL and XPS spectra. However, when the treatment temperature rises to 145°C, the mobility is dramatically reduced to 10.41 cm²/Vs. This probably causes shedding of the ZnO thin films, as the temperature rises. Thus, it can be concluded that the quality of the TFTs, and the structural and optical properties of the thin films depend strongly on the treatment temperature.
CONCLUSION

In summary, the effect of treatment temperature in SILAR-deposited ZnO-TFTs was investigated. Data from PL and XPS have revealed that a temperature rise during ethylene glycol rinsing directly affects the distribution of defects in the films. At low temperatures, the presence of a large number of these defects is attributed to the presence of Zn(OH)2 in the films, thus affecting the threshold voltage, a TFT transfer characteristic. During the rise in temperature, the threshold voltage increases as a consequence of the reduction in oxygen, which acts as a donor-like defect? As a result, it can be inferred that the properties of ZnO films and ZnO-TFTs are highly dependent on treatment temperature in the SILAR method.

REFERENCES

CITATION OF THIS ARTICLE